



IN THE

UNITED STATES PATENT AND TRADEMARK OFFICE

Jong-Ho LEE, et al.

09/776,059

Examiner:

Not Yet Assigned

Filing Date:

February 1, 2001

Group Art Unit:

1773

Title:

DIELECTRIC LAYER FOR SEMICONDUCTOR DEVICE AND METHOD FOR

MANUFACTURING THE SAME

Box DD

ASSISTANT COMMISSIONER FOR PATENTS

Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT

Sir:	Chia Information Disclosure Statement is submitted:
	This Information Disclosure Statement is submitted:
_	☑ under 37 CFR 1.97 (b), or □
•	This Information Disclosure Statement is submitted: under 37 CFR 1.97 (b), or (Within three months of filing national application; or date of entry of International application; or before mailing date of first office action on the merits; whichever occurs last)
	or before mailing date of first office action on the merits; whichever occurs last)
ſ	under 37 CFR 1.97 (c) together with either a:
_	Statement under 37 CFR 1.97 (e), or
	a \$240 fee under 37 CFR 1.17 (p), or
	(After mailing of first Office Action, but prior to Notice of Allowance or Final Office Action)
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[] copies of	under 37 CFR 1.97 (d) together with either: Statement under 37 CFR 1.97 (e), Applicant hereby petitions for the consideration of the accompanyin information disclosure statement (37 C.F.R. §1.97(d)(ii). a \$130.00 petition fee set forth in 37 CFR 1.17 (i)(1). (Filed after final action or notice of allowance, whichever occurs first, but before payment of the patients, publications or other information of which applicant(s) are aware, which applicant(s) believe(september 1.50 per payment of this applicant of the examination of this application and for which there may be a duty to disclose in accordance of this application and for which there may be a duty to disclose in accordance of this application and for which there may be a duty to disclose in accordance.

It is requested that the information disclosed herein be made of record in this application.

Any deficiency or overpayment should be charged or credited to deposit account number 13-1703. A duplicate copy of this sheet is enclosed.

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with 37 CFR 1.56.

PATENT TRADEMARK OFFICE

Respectfully submitted,

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PATENT APPLICATION

Serial No.

09/776,059

Group:

1773

INFORMATION DISCLOSURE CITATION FORM PTO-1449 (Modified)

U.S. PATENT DOCUMENTS

Exam <u>Init</u>	<u>Ref</u>	Document <u>Number</u>	Issue <u>Date</u>	<u>Name</u>	Class	Sub- <u>Class</u>		
		5,923,056	07/13/99	Lee, et al.				
		6,013,553	01/11/00	Wallace, et al.				
		6,020,024	02/01/00	Maiti, et al.				
		6,020,243	02/01/00	Wallace, et al.				
		6,060,755	05/09/00	Ma, et al.				
FOREIGN PATENT DOCUMENTS								
		Document <u>Number</u>		Publication <u>Date</u>	Country	y <u>Name</u>		
OTHER DOCUMENTS								
Exam <u>Init</u>	Ref	(Including Author, Title, Date, Pertinent Pages, etc.						
		Wilk, G.D. and Wallace, R.M.; "Electrical Properties of hafnium silicate gate dielectrics deposited directly on silicon"; <u>Applied Physics Letters</u> ; pp 2854-2856 (1999)						
	<u></u>							
Examiner:								
Date Considered:								